Solar Probe Plus

A NASA Mission to Touch the Sun

APL Caltech

ENERGETIC

Integrated Science Investigation of the Sun Energetic Particles

Preliminary Design Review 05 – 06 NOV 2013

EPI-Lo Technology Development

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Outline



- EPI-Lo Technology Developments to TRL6
- Performance Requirements and Derivation
- Energy System Development
 - Fidelity of Test Article
 - Test and Analysis Results
- Sensor / Timing System Development
 - Fidelity of Test Article
 - Test and Analysis Results
- TOF-D/CFD-D ASIC Development
 - Fidelity of Test Article
 - Test and Analysis Results
- Transition to Flight



EPI-Lo Technology Developments to TRL6



- Species composition driven by two systems, energy system and timing system
- Energy and TOF performance to meet 3He / 4He separation
 - 3He, 4He: 0.5 FWHM AMU for incoming energies between ≤0.2 MeV and ≥2.0MeV
 - Validate one anode covering two sensors has adequate timing performance – quadrant anode design uses significantly less readout electronics than an octant design
 - Validate SSD has adequate energy performance
- TOF-D and CFD-D ASIC development



EPI-Lo Performance Modeling



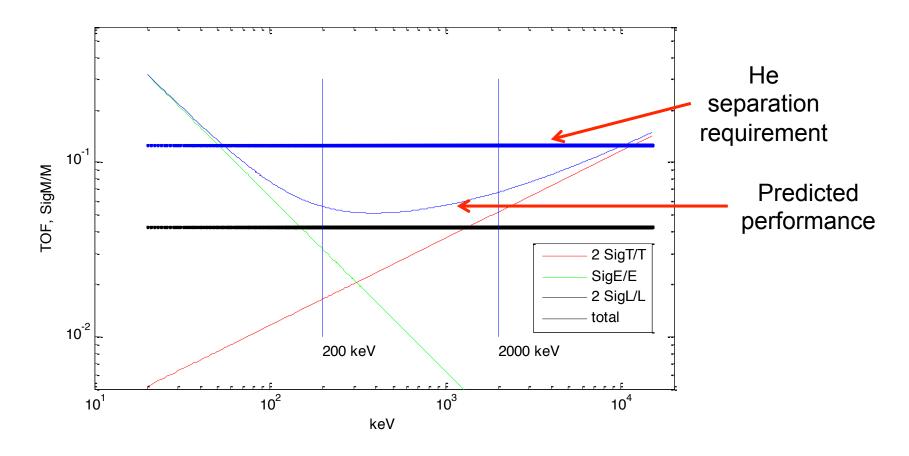
- Two independent models used
 - Monte-Carlo
 - Inputs are timing noise, SSD noise, and path length variation
 - Inputs can by any distribution (not limited to Gaussian)
 - Analytical
 - Inputs are timing noise, SSD noise, and path length variation
 - All inputs are Gaussian
 - The two models have been compared and shown to give identical results
 - Does not include foil losses (not significant for >200keV He)
- Modeling shows 400pS FWHM, 15keV FWHM performance comfortably meets requirements



He separation requirements



- At low energies the energy resolution dominates performance
- At high energies the timing resolution dominates performance
- Predicted performance has ample margin from requirement

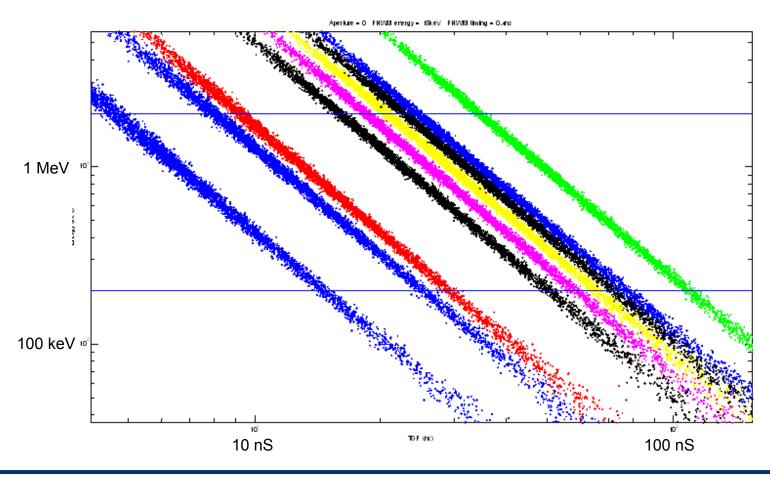




Track Simulations



 Monte-carlo model for all species with 400pS FWHM timing and 15keV FWHM energy resolutions



Energy System Development

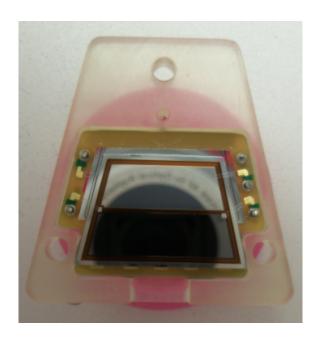


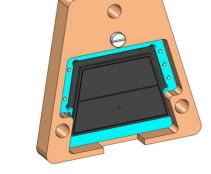
Solid State Detector is fabricated and mounted to carrier board

Energy board is fabricated and populated

■ All components nearly identical to flight – no design changes

expected





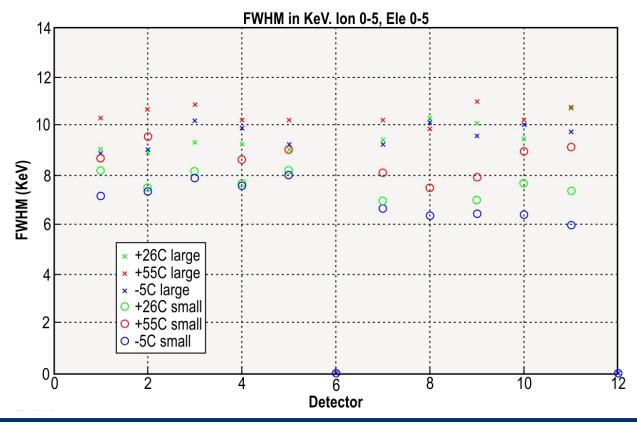




RBSPICE DATA with 60keV X-ray source



- SSD performance base-lined on RBSPICE instrument tested with 60keV Xray
- Performance is ~11keV FWHM over a wide temperature range
- EPI-Lo SSD in testing now preliminary results show <15keV FWHM at 60keV





Timing performance: Timing Budget



• Electron Dispersion: 200pS

■ TOF-D ASIC: 200pS

CFD-D ASIC: 200pS

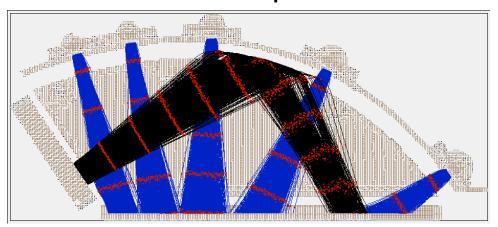
■ Total: 350pS (requirement is 400pS)

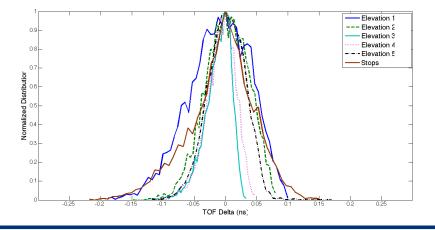


Timing budget – secondary electron dispersion simulations



- 250 ps Time Markers
- Electron dispersion (start and stop combined) for worse case elevation 1 is 150pS





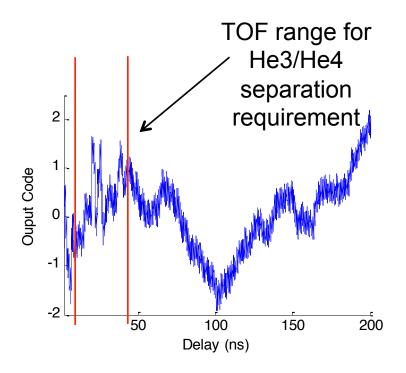
Name	Mean TOF (ns) FWHM (ns)	
Elevation 1	0.93	0.12
Elevation 2	2.12	0.08
Elevation 3	2.35	0.04
Elevation 4	2.32	0.05
Elevation 5	2.26	0.08
Stops	5.23	0.09

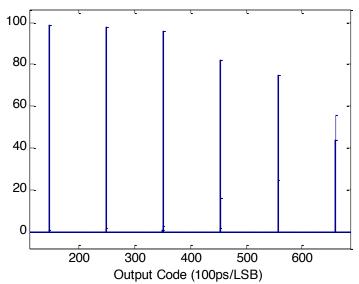


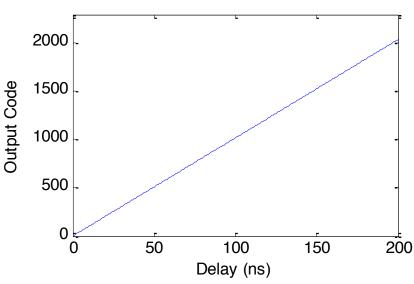
TOF-D Test Results



- TOF-D performance meets requirement
- INL variations compensated for with look-up-tables
 - Same LUTs used to normalize path length for different apertures
- Jitter is less than 1 LSB FWHM





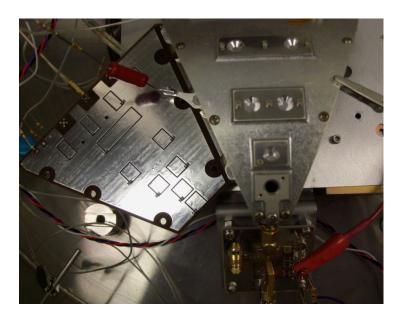


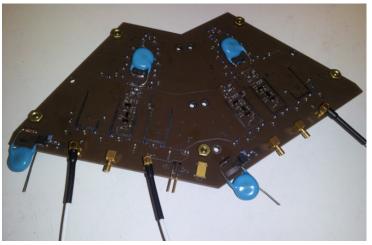


Prototype Quadrant Sensor Testing



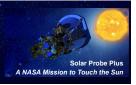
- Timing performance testing completed on prototype sensor
- End-to-end test includes variations due to electron dispersion, anode board performance, and CFD-D V0 performance
 - Does not include TOF-D ASIC
- Prototype anode board is close to flight configuration
 - HV isolation in imbedded capacitance
 - Start delay line covers two sensors
 - Does not mechanically fit flight design
- Prototype sensor is similar to flight sensor – key sensor geometries are the same



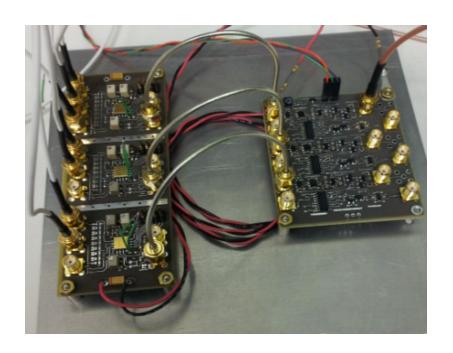


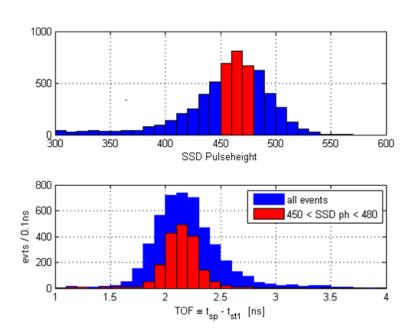


Prototype Quadrant Sensor Testing



- Initial results show about 300pS FWHM timing performance (CFD-D and electron optics contributions), which meets our requirements.
- The final version of the CFD-D has lower jitter at low thresholds and reduced walk, which we expect will improve performance.



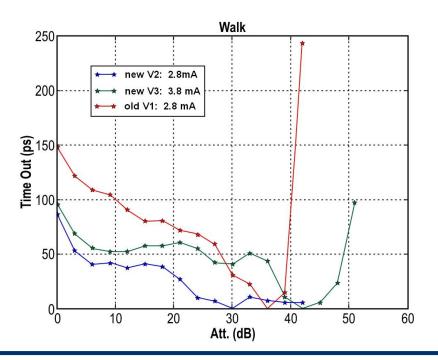




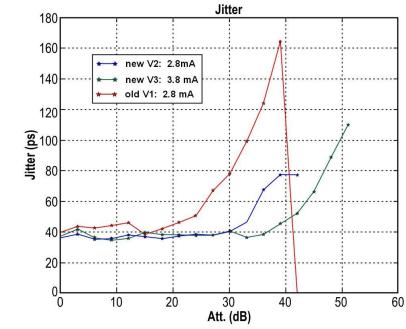
CFD-D test results



- CFD-D extensively tested using the CFD-D test board
- CFD-D V3 has improved performance









Technical Development: ASIC Progress



- First version of TOF-D chip fabricated and tested
 - Temperature testing from -40°C TO 70°C
 - Supply tested from 3.0V to 3.6V
 - Functionality verified over 10ps to 2ns LSB
 - Successfully completed SEE testing at Texas
 A&M
 - Completed total dose testing
- Second version of TOF-D chip and first version of CFD-D chip fabricated and tested
- Flight Fabrication Third version of TOF-D chip and second version of CFD-D chip fabricated and tested
 - Temperature testing from -40°C TO 70°C
 - Supply tested from 3.0V to 3.6V
 - TOF-D functionality verified over 10ps to 2ns LSB
 - Working with vendor for final qualification of both ASICs





Transition to Flight



- TOF-D, CFD-D ASICs
 - Complete qualification with external test house
 - Parts are needed in early 2014 for SIS instrument EPI-Lo not the driver
 - Complete radiation testing on flight parts (prototype parts passed all radiation testing)
- Sensor Development
 - Build and test EM sensor
 - Integrate sensor with SSD
- SSD
 - EM design complete
 - Finish testing EM SSD
 - Flight design will be identical
- All critical performance metrics for quadrant anode design have been verified with prototype testing